

SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor

- Samsung P/N : **CL21B102KBANNL**
- Description : **CAP, 1nF, 50V, ±10%, X7R, 0805**

A. Samsung Part Number

CL **21** **B** **102** **K** **B** **A** **N** **N** **N** **L**
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor									
② Size	0805 (inch code)	L: 2.0 ± 0.1	mm	W: 1.25 ± 0.1	mm					
③ Dielectric	X7R				⑧ Inner electrode	Ni				
④ Capacitance	1 nF				Termination	Cu				
⑤ Capacitance tolerance	±10 %				Plating	Sn 100% (Pb Free)				
⑥ Rated Voltage	50 V				⑨ Product	Normal				
⑦ Thickness	0.65 ± 0.1	mm				⑩ Special	Reserved for future use			
						⑪ Packaging	Cardboard Type, 13" reel			

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms
Tan δ (DF)	0.025 max.	
Insulation Resistance	10,000Mohm or 500Mohm·μF Whichever is Smaller	Rated Voltage 60~120 sec.
Appearance	No abnormal exterior appearance	Microscope (×10)
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
Temperature Characterisitcs	X7R (From -55℃ to 125℃, Capacitance change should be within ±15%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g·F, for 10±1 sec.
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
Resistance to Soldering heat	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within $\pm 5\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours $\times$ 3 direction (x, y, z)
Moisture Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.05 max IR : 500Mohm or 25Mohm $\cdot \mu F$ Whichever is Smaller	With rated voltage 40 $\pm 2^\circ C$, 90~95%RH, 500+12/-0hrs
High Temperature Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.05 max IR : 1000Mohm or 50Mohm $\cdot \mu F$ Whichever is Smaller	With 200% of the rated voltage Max. operating temperature 1000+48/-0hrs
Temperature Cycling	Capacitance change : within $\pm 7.5\%$ Tan δ , IR : initial spec.	1 cycle condition Min. operating temperature $\rightarrow 25^\circ C$ $\rightarrow$ Max. operating temperature $\rightarrow 25^\circ C$ 5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^\circ C$, 10sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Multilayer Ceramic Capacitors MLCC - SMD/SMT](#) ***category:***

Click to view products by [Samsung](#) ***manufacturer:***

Other Similar products are found below :

[M39014/01-1467](#) [M39014/02-1218V](#) [M39014/02-1225V](#) [M39014/02-1262V](#) [M39014/02-1301](#) [M39014/22-0631](#) [1210J5000102JCT](#)
[1210J2K00102KXT](#) [1210J5000103KXT](#) [1210J5000223KXT](#) [D55342E07B379BR-TR](#) [D55342E07B523DR-T/R](#) [1812J1K00103KXT](#)
[1812J1K00473KXT](#) [1812J2K00680JCT](#) [1812J4K00102MXT](#) [1812J5000102JCT](#) [1812J5000103JCT](#) [1812J5000682JCT](#) [NIN-FB391JTRF](#)
[NIN-FC2R7JTRF](#) [NPIS27H102MTRF](#) [C1206C101J1GAC](#) [C1608C0G1E472JT000N](#) [C2012C0G2A472J](#) [2220J2K00101JCT](#)
[KHC201E225M76N0T00](#) [1812J1K00222JCT](#) [1812J2K00102KXT](#) [1812J2K00222KXT](#) [1812J2K00472KXT](#) [2-1622820-7-CUT-TAPE](#)
[2220J3K00102KXT](#) [2225J2500824KXT](#) [CCR07CG103KM](#) [CGA2B2C0G1H010C](#) [CGA2B2C0G1H040C](#) [CGA2B2C0G1H050C](#)
[CGA2B2C0G1H060D](#) [CGA2B2C0G1H070D](#) [CGA2B2C0G1H151J](#) [CGA2B2C0G1H1R5C](#) [CGA2B2C0G1H2R2C](#) [CGA2B2C0G1H3R3C](#)
[CGA2B2C0G1H680J](#) [CGA2B2C0G1H6R8D](#) [CGA2B2X8R1H221K](#) [CGA2B2X8R1H472K](#) [CGA3E1X7R1C474K](#)
[CGA3E2C0G1H561JT0Y0N](#)